Datacon 2200 evo advanced

Accuracy & Flexibility for your mass production

The new Datacon 2200 evo advanced is the latest edition in the well-established and field proven Multi Module Attach platform of Besi.

With an all new gantry & controller system as well as a completely new vision and camera generation Datacon 2200 evo advanced offers superb 3µm placement accuracy while still focusing on your productivity and throughput requirements.

While significantly increasing the accuracy and placement capabilities the Datacon 2200 evo advanced does not forget its roots in the Multi Module Attach family. It is still offering the unbeaten flexibility as well as the full customization capability that the Datacon 2200 evo platform is so well known for.

3µm @ 3s !
Accuracy
• ± 3µm @ 3s placement accuracy
• ± 0.07° @ 3s rotational accuracy
• New vision, optics and camera system
• Various configurable (FOV & resolution) set of cameras
• 3D & contactless height measurement options

Multi Chip
• Max. 14 different pick up tools / nozzles
• 5 eject tools
• 3 different epoxies / adhesive in a single pass
• Any flip chip / face up die combination
• Dual module for even higher productivity (option)

Bonding
• 0.05 - 25N closed loop bond-force
• 0 – 360° bond rotation
• Heated bond head (max. 450°C) (option)
• UV curing with up to 2000mW/cm² (365 / 405nm) (option)

Dispensing
• High end auger pump
• Time pressure dispensing
• Piezo jetter valves
• Pin transfer
• Auto epoxy volume control

Machine Performance
• x/y placement ± 3µm @ 3s
• Theta accuracy ± 0.07° @ 3s
• 0 – 360° rotation
• ≤ 450°C bond head heating
• ≤ 150°C bond insert heating
• In situ UV curing option
• 3/5/12 MPix cameras
• 1.8 – 12mm F0V

Substrates
• 13”x 8” max. working area
• FR4, lead-frame, strips, carrier, boat, ceramics, wafer

Components
• size: 0.17 mm – 30 mm
• thickness: 0.05 mm – 17 mm
• wafer, waffle-pack, gel-pack, feeder, tray

Machine
• W x D x H: 1160 x 1225 x 1800mm
• Weight: ± 1450kg /module
• 3x 400 VAC | 50/60 Hz | 2.3 kVA
• 6.0 bar CDA
• -0.8 bar vacuum
• 18 – 22°C ambient temperature